506473696 01/28/2021

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

EPAS ID: PAT6520472

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
YEMAO SHEN	11/23/2016
DEMING GU	11/23/2016
HENG QUE	11/23/2016
WEI ZHANG	11/23/2016

RECEIVING PARTY DATA

Name:	VIA ALLIANCE SEMICONDUCTOR CO., LTD.
Street Address:	ROOM 301, NO.2537, JINKE ROAD, ZHANGJIANG HI-TECH PARK
City:	SHANGHAI
State/Country:	CHINA
Postal Code:	201203

PROPERTY NUMBERS Total: 1

Property Type	Number		
Application Number:	17160556		

CORRESPONDENCE DATA

Fax Number: (404)521-4286

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 678-483-8899

Email: dan.mcclure@mqrlaw.com

MCCLURE, QUALEY & RODACK, LLP **Correspondent Name:** 280 INTERSTATE NORTH CIRCLE SE Address Line 1:

Address Line 2: **SUITE 550**

Address Line 4: ATLANTA, GEORGIA 30339

ATTORNEY DOCKET NUMBER:	252229-1731	
NAME OF SUBMITTER:	DANIEL R. MCCLURE	
SIGNATURE:	/Daniel R. McClure/	
DATE SIGNED:	01/28/2021	

Total Attachments: 2

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> **PATENT REEL: 055059 FRAME: 0109** 506473696

ASSIGNMENT

WHEREAS,	Yemao	SHEN,	Deming	GU,_	Heng	QUE,	and	Mer	ZHANG	
rereafter referred										as
described and set f										
Title: METHODS FO	OR COMPR	ESSING A	AND DECO	MPRE	SSING T	EXTURE	TILES	AND A	APPARATUSES	
USING THE SAME										
Filed:			-	Serial	No					
Executed on:								- T		
 -										

WHEREAS, VIA Alliance Semiconductor Co., Ltd. of Room 301, No.2537, Jinke Road, Zhangjiang Hi-Tech Park, Shanghai 201203, P.R. China hereinafter referred to as ASSIGNEB, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

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ASSIGNMENT

Yemas SHEN	November 23, 2016
Yemao SHEN	Date
pmy lan	November 23, 2016
Deming GU	Date
Heng Que	November 23, 2016
Heng QUE	Date
Wei 2HANG	November 23, 2016
Wei ZHANG	Date

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